

FIG. 2 shows a contact plug 7 and the contact is meant to be to the right of field oxide 4.

Another field oxide region 11 is deposited over a portion of the contact region 12, and the metal plug 7 which would have usually been placed to end on the contact region 12 ends up on the field oxide region 11 instead.



 L_{10} is the overlap area between the oxide region 11, the normal contact region 12 and the placing of the plug 7. The diameter of the plug 7 is preferably not larger than the size of the minimum feature. L_{10} can be of any size, specified by the fabrication vendor, and is preferably 10% larger than the size of the minimum feature. A preferred contact dimension is up to about three times of the via size.

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17. (New) The device of Claim 1, wherein said field oxide layer has an uppermost side, said metal plug contact being disposed on said uppermost side of said field oxide layer.

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- 18. (New) The method of Claim 5, wherein said field oxide layer has an uppermost side, said metal plug contact being disposed on said uppermost side of said field oxide layer
- 19. (New) The device of Claim 9, wherein said field oxide layer has an uppermost side, said metal plug contact being disposed on said uppermost side of said field oxide layer.
- 20. (New) The method of Claim 13, wherein said field oxide layer has an uppermost side, said metal plug contact being disposed on said uppermost side of said field oxide layer.